Vishay Semiconductors

COMPLIANT

HALOGEN

Thyristor High Voltage, Surface Mount Phase Control SCR, 16 A



PRIMARY CHARACTERISTICS							
I _{T(AV)}	10 A						
V _{DRM} /V _{RRM}	800 V, 1200 V						
V_{TM}	1.4 V						
I _{GT}	60 mA						
TJ	-40 °C to 125 °C						
Package	D ² PAK (TO-263AB)						
Circuit configuration	Single SCR						

FEATURES

 Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C

 Designed and qualified according JEDEC®-JESD 47

 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Input rectification (soft start)
- Vishay input diodes, switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-16TTS..S-M3 high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS									
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS									
NEMA FR-4 or G-10 glass fabric-based epoxy with 4 oz. (140 μm) copper	2.5	3.5							
Aluminum IMS, R _{thCA} = 15 °C/W	6.3	9.5	А						
Aluminum IMS with heatsink, R _{thCA} = 5 °C/W	14.0	18.5							

Note

• $T_A = 55$ °C, $T_J = 125$ °C, footprint 300 mm²

MAJOR RATINGS AND CHARACTERISTICS									
PARAMETER	TEST CONDITIONS	VALUES	UNITS						
I _{T(AV)}	Sinusoidal waveform	10	۸						
I _{RMS}		16	A						
V _{RRM} /V _{DRM}		800 to 1200	V						
I _{TSM}		200	A						
V _T	10 A, T _J = 25 °C	1.4	V						
dV/dt		500	V/µs						
dl/dt		150	A/µs						
TJ		-40 to +125	°C						

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA						
VS-16TTS08S-M3	800	800	10						
VS-16TTS12S-M3	1200	1200	10						



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ABSOLUTE MAXIMUM RATINGS		T.		1		1	
PARAMETER	SYMBOL		TEST CONDITIONS	VAL	UNITS		
ADAMETER	OTMEGE		1231 GONDITIONS			0.11.10	
Maximum average on-state current	I _{T(AV)}	$T_{\rm C} = 98 {}^{\circ}{\rm C}, {}^{2}$	1				
Maximum RMS on-state current	I _{RMS}			1	Α		
Maximum peak, one-cycle,		10 ms sine p	ulse, rated V _{RRM} applied	1	70		
non-repetitive surge current	I _{TSM}	10 ms sine p	ulse, no voltage reapplied	20	00		
Maximum 12t for fusing	I ² t	10 ms sine p	ulse, rated V _{RRM} applied	144		A2-	
Maximum I ² t for fusing	I ² ξ	10 ms sine p	200		- A ² s		
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to	10 ms, no voltage reapplied	2000		A²√s	
Maximum on-state voltage drop	V_{TM}	10 A, T _J = 25	10 A, T _J = 25 °C			V	
On-state slope resistance	r _t	T 105 %		24.0		mΩ	
Threshold voltage	V _{T(TO)}	T _J = 125 °C		1.1		V	
Maximum various and direct lockers current	1 /1	T _J = 25 °C	$V_R = \text{rated } V_{RRM} / V_{DRM}$	0.5			
Maximum reverse and direct leakage current	I_{RM}/I_{DM}	T _J = 125 °C	T _J = 125 °C		0		
Holding current	I _H	Anode suppl T _J = 25 °C	Anode supply = 6 V, resistive load, initial I_T = 1 A, I_J = 25 °C		150	mA	
Maximum latching current	ΙL	Anode suppl	00	1			
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max.}$	$T_J = T_J$ max. linear to 80 % $V_{DRM} = R_g - k = open$			V/µs	
Maximum rate of rise of turned-on current	dl/dt				150		

TRIGGERING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum peak gate power	P _{GM}		8.0	W				
Maximum average gate power	P _{G(AV)}		2.0	VV				
Maximum peak positive gate current	+ I _{GM}		1.5	Α				
Maximum peak negative gate voltage	- V _{GM}		10	V				
		Anode supply = 6 V, resistive load, T _J = - 10 °C	90					
Maximum required DC gate current to trigger	I _{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C		mA				
		Anode supply = 6 V, resistive load, T _J = 125 °C	35					
		Anode supply = 6 V, resistive load, T _J = - 10 °C	3.0					
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	2.0	V				
		Anode supply = 6 V, resistive load, T _J = 125 °C	1.0	V				
Maximum DC gate voltage not to trigger	V_{GD}	T 105 °C V Detect value	0.25					
Maximum DC gate current not to trigger	I_{GD}	T _J = 125 °C, V _{DRM} = Rated value	2.0	mA				

SWITCHING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Typical turn-on time	t _{gt}	T _J = 25 °C	0.9					
Typical reverse recovery time	t _{rr}	T _{.1} = 125 °C	4	μs				
Typical turn-off time	t _q	1 _J = 125 G	110					

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THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	VALUES	UNITS							
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +125	°C					
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	1.3	°C/W					
Typical thermal resistance, junction to ambient	R _{thJA}	PCB mount (1)	40	C/VV					
Approximate weight			2	g					
Approximate weight			0.07	oz.					
Marking device		Consist to D2DALY (TO OCCAD)		08S					
ividi nii ig device		Case style D ² PAK (TO-263AB)	16TTS12S						

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W. For recommended footprint and soldering techniques refer to application note #AN-994

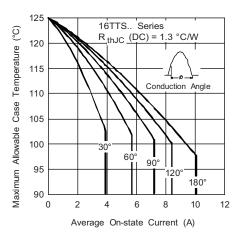


Fig. 1 - Current Rating Characteristics

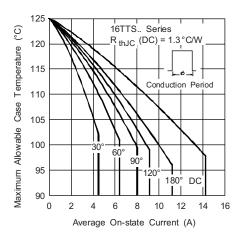


Fig. 2 - Current Rating Characteristics

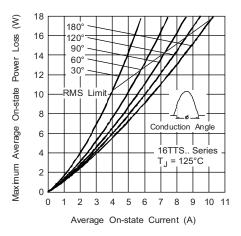


Fig. 3 - On-State Power Loss Characteristics

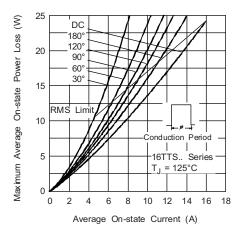


Fig. 4 - On-State Power Loss Characteristics

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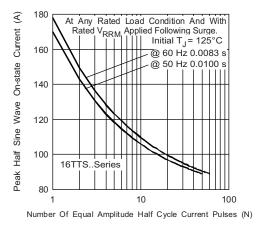


Fig. 5 - Maximum Non-Repetitive Surge Current

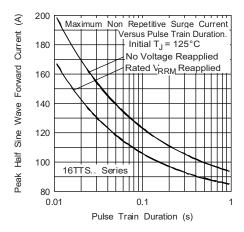


Fig. 6 - Maximum Non-Repetitive Surge Current

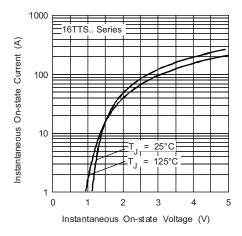


Fig. 7 - On-State Voltage Drop Characteristics

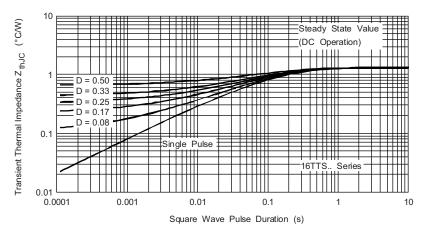


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

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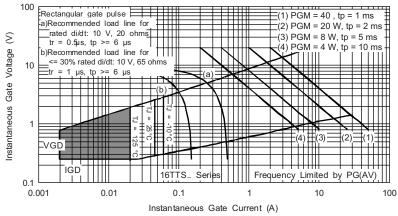
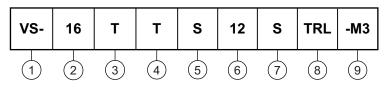


Fig. 9 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating

- Circuit configuration:

T = single thyristor

4 - Package:

 $T = D^2PAK (TO-263AB)$

5 - Type of silicon:

S = standard recovery rectifier

6 - Voltage rating: voltage code x 100 = V_{RRM} - 08 = 800 V 12 = 1200 V

7 - S = surface mountable

8 - • None = tube

• TRL = tape and reel (left oriented)

• TRR = tape and reel (right oriented)

9 - -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)									
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION							
VS-16TTS08S-M3	50	Antistatic plastic tubes							
VS-16TTS08STRL-M3	800	13" diameter plastic tape and reel							
VS-16TTS08STRR-M3	800	13" diameter plastic tape and reel							
VS-16TTS12S-M3	50	Antistatic plastic tubes							
VS-16TTS12STRL-M3	800	13" diameter plastic tape and reel							
VS-16TTS12STRR-M3	800	13" diameter plastic tape and reel							

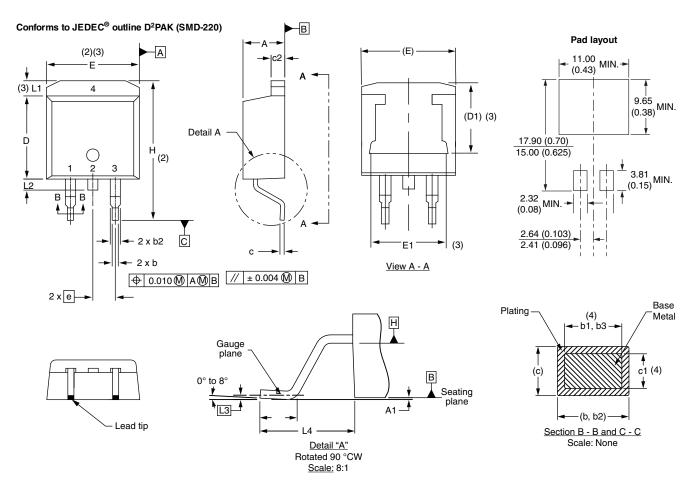
LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?96164						
Part marking information	www.vishay.com/doc?95444						
Packaging information	www.vishay.com/doc?96424						
SPICE model	www.vishay.com/doc?96772						



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D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	INCHES		NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

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